

# AO3400A

## 30V N-Channel MOSFET

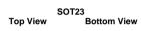
## **General Description**

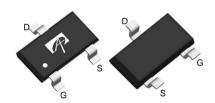
The AO3400A combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{\text{DS}(\text{ON})}.$  This device is suitable for use as a load switch or in PWM applications.

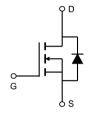
## **Product Summary**

 $\begin{array}{lll} V_{DS} & 30V \\ I_{D} \; (at \, V_{GS} \! = \! 10V) & 5.7A \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 10V) & < 26.5 m\Omega \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 4.5V) & < 32 m\Omega \\ R_{DS(ON)} \; (at \, V_{GS} \! = \! 2.5V) & < 48 m\Omega \end{array}$ 









Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	±12	V	
Continuous Drain Current	T <sub>A</sub> =25°C		5.7		
	T <sub>A</sub> =70°C	'D	4.7	A	
Pulsed Drain Current C		I <sub>DM</sub>	30		
	T <sub>A</sub> =25°C	В	1.4	W	
Power Dissipation <sup>B</sup>	T <sub>A</sub> =70°C	P <sub>D</sub>	0.9	VV	
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

Thermal Characteristics								
Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s	D	70	90	°C/W			
Maximum Junction-to-Ambient AD	Steady-State	$R_{\theta JA}$	100	125	°C/W			
Maximum Junction-to-Lead Steady-State		$R_{\theta JL}$	63	80	°C/W			



#### Electrical Characteristics (T<sub>.1</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μА
		T <sub>J</sub> =55°C	:		5	μΑ
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS}$ =0V, $V_{GS}$ = ±12V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$	0.65	1.05	1.45	V
$I_{D(ON)}$	On state drain current	$V_{GS}$ =4.5V, $V_{DS}$ =5V	30			Α
R <sub>DS(ON)</sub> Static I	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =5.7A		18	26.5	mΩ
		T <sub>J</sub> =125°C	;	28	38	1115.2
	Static Drain-Source On-Itesistance	$V_{GS}$ =4.5V, $I_D$ =5A		19	32	mΩ
		$V_{GS}$ =2.5V, $I_D$ =3A		24	48	$m\Omega$
g <sub>FS</sub>	Forward Transconductance	$V_{DS}$ =5V, $I_D$ =5.7A		33		S
$V_{SD}$	Diode Forward Voltage	I <sub>S</sub> =1A,V <sub>GS</sub> =0V		0.7	1	V
Is	Maximum Body-Diode Continuous Curre			2	Α	
DYNAMIC	PARAMETERS					
C <sub>iss</sub>	Input Capacitance			630		pF
Coss	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =15V, f=1MHz		75		pF
$C_{rss}$	Reverse Transfer Capacitance			50		pF
$R_g$	Gate resistance	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz	1.5	3	4.5	Ω
SWITCHI	NG PARAMETERS					
$Q_g$	Total Gate Charge			6	7	nC
$Q_{gs}$	Gate Source Charge	$V_{GS}$ =4.5V, $V_{DS}$ =15V, $I_{D}$ =5.7A		1.3		nC
$Q_{gd}$	Gate Drain Charge	1		1.8		nC
t <sub>D(on)</sub>	Turn-On DelayTime			3		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =15V, $R_{L}$ =2.6 $\Omega$ ,		2.5		ns
t <sub>D(off)</sub>	Turn-Off DelayTime	$R_{GEN}=3\Omega$		25		ns
t <sub>f</sub>	Turn-Off Fall Time	]		4		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	$I_F$ =5.7A, dI/dt=100A/ $\mu$ s		8.5		ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =5.7A, dI/dt=100A/μs		2.6	_	nC

A. The value of R<sub>BJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25° C. The value in any given application depends on the user's specific board design.

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B. The power dissipation  $P_D$  is based on  $T_{J(MAX)}$ =150° C, using  $\leq$  10s junction-to-ambient thermal resistance.

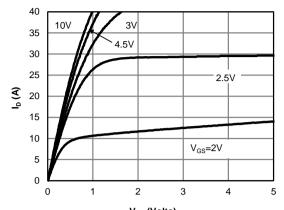
C. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150° C. Ratings are based on low frequency and duty cycles to keep initialT<sub>1</sub>=25° C.

D. The  $R_{\text{NJA}}$  is the sum of the thermal impedence from junction to lead  $R_{\text{NJL}}$  and lead to ambient. E. The static characteristics in Figures 1 to 6 are obtained using <300 $\mu$ s pulses, duty cycle 0.5% max.

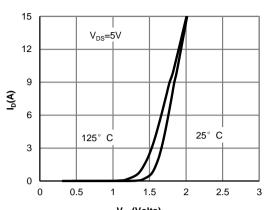
F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T<sub>J(MAX)</sub>=150° C. The SOA curve provides a single pulse rating.



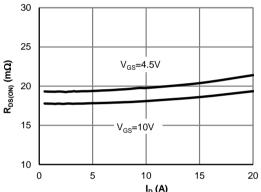
#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



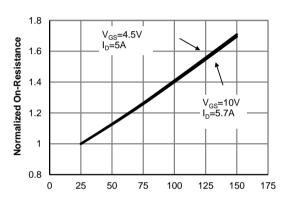
V<sub>DS</sub> (Volts) Fig 1: On-Region Characteristics (Note E)



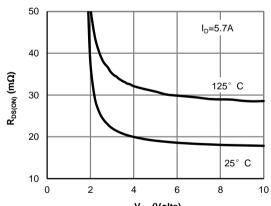
V<sub>GS</sub>(Volts) Figure 2: Transfer Characteristics (Note E)



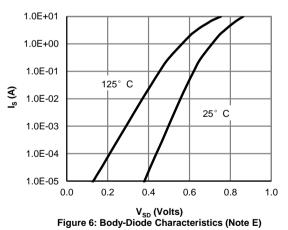
 $\label{eq:ldot} \textbf{I}_{D}\left(\textbf{A}\right)$  Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)



Temperature (°C)
Figure 4: On-Resistance vs. Junction Temperature
(Note E)



V<sub>GS</sub> (Volts)
Figure 5: On-Resistance vs. Gate-Source Voltage
(Note E)





#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

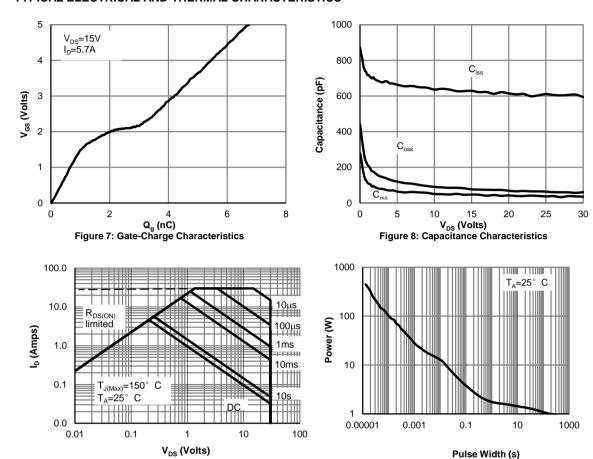
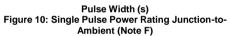
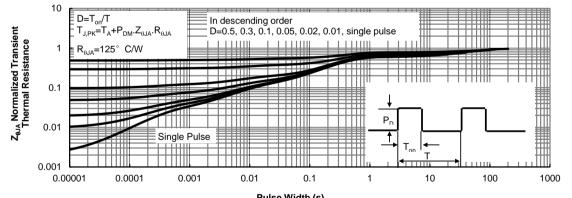


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

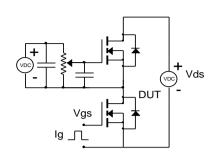


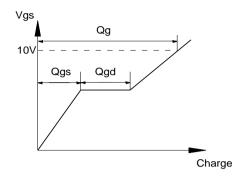


Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

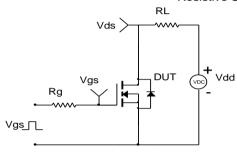


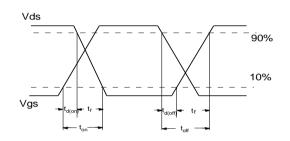
## Gate Charge Test Circuit & Waveform





## Resistive Switching Test Circuit & Waveforms





### Diode Recovery Test Circuit & Waveforms

